Svetlana 3CX10,000H3 Medium-Mu Industrial Power Triode



he Svetlana™ 3CX10,000H3 is a rugged high-performance industrial ceramic/ metal power triode designed for use in amplifier, oscillator, or modulator service. The ceramic is glazed to facilitate cleaning when used in an industrial environment. A modern mesh filament is used, replacing the old-fashioned hairpin construction. The improved mesh filament design ensures better mechanical rigidity and long lasting concentricity of the filament, contributing to longer life. The mesh filament also provides improved RF efficiency at VHF operation. Flexible leads connect to the filament terminals and a flange is connected to the grid. The flange provides a convenient way to mount the tube.

The Svetlana 3CX10,000H3 is manufactured in the Svetlana Electron Devices complex in St. Petersburg, Russia. Svetlana has achieved the improved performance described above with exact replacement compatibility with the 3CX10,000H3 manufactured in the United States.



Svetlana 3CX10,000H3

Electrical					
Filament	Thoriate	ed-tungsten i	mesl		
Voltage	7.50 ±0.37 V				
Current @ 7.50V		99	±5 A		
Amplification factor (average)			2		
Direct interelectrode capacitances (grounded filame	ent):				
Input	•	53	.0 pl		
Output	1.5 pF				
Feedback	34 pF				
Maximum frequency for full ratings (CW)			MH.		
Mechanical					
Cooling		Force	ed a		
Base	F	lying leads/fl			
Socketing		. Mounting fl			
Operating position		Base up or			
Maximum operating temperature	v or troar,		50°		
Maximum dimensions:					
Length (including filament leads)	15	00 cm (17 7	75 in		
Diameter		45.09 cm (17.75 in.			
Net weight		17.91cm (7.05 in. 5.5 kg (12 lb			
DC plate current		5.0			
RF Power Amplifier or Oscillator, Class C, (Fil Maximum Ratings	itered DC Plate Po	wer Supply	<u>) </u>		
DC plate voltage		10,000			
-			-		
Plate dissipation					
		10,000			
		250	l		
DC grid voltage		250 -1000	l		
DC grid voltage DC grid current		250 -1000 0.6	l		
DC grid voltage DC grid current Plate input power		250 -1000	l		
DC grid voltage DC grid current Plate input power Typical Operation		250 -1000 0.6	l		
DC grid voltage DC grid current Plate input power Typical Operation (Frequencies to 30MHz)		250 -1000 0.6 40,000			
DC grid voltage DC grid current Plate input power Typical Operation (Frequencies to 30MHz) DC plate voltage	7000	250 -1000 0.6 40,000			
DC grid voltage DC grid current Plate input power Typical Operation (Frequencies to 30MHz) DC plate voltage DC plate current	4.0	250 -1000 0.6 40,000 9000 4.0	l l		
DC grid voltage DC grid current Plate input power Typical Operation (Frequencies to 30MHz) DC plate voltage DC plate current DC grid voltage*	4.0 -670	250 -1000 0.6 40,000 9000 4.0 -930	V		
DC grid voltage DC grid current Plate input power Typical Operation (Frequencies to 30MHz) DC plate voltage DC plate current DC grid voltage* DC grid current*	4.0 -670 275	250 -1000 0.6 40,000 9000 4.0 -930 430	V.		
DC grid voltage DC grid current Plate input power Typical Operation (Frequencies to 30MHz) DC plate voltage DC plate current DC grid voltage* DC grid current* Peak RF grid voltage*	4.0 -670	250 -1000 0.6 40,000 9000 4.0 -930 430 390	l l		
Grid dissipation DC grid voltage DC grid current Plate input power Typical Operation (Frequencies to 30MHz) DC plate voltage DC plate current DC grid voltage* DC grid current* Peak RF grid voltage* Driving Power*	4.0 -670 275 340 260	250 -1000 0.6 40,000 9000 4.0 -930 430 390 570	l l		
DC grid voltage DC grid current Plate input power Typical Operation (Frequencies to 30MHz) DC plate voltage DC plate current DC grid voltage* DC grid current* Peak RF grid voltage* Driving Power* Plate input power	4.0 -670 275 340 260 28,000	250 -1000 0.6 40,000 9000 4.0 -930 430 390 570 36,000	m.		
DC grid voltage DC grid current Plate input power Typical Operation (Frequencies to 30MHz) DC plate voltage DC plate current DC grid voltage* DC grid current* Peak RF grid voltage* Driving Power* Plate input power Plate dissipation	4.0 -670 275 340 260 28,000 9000	250 -1000 0.6 40,000 9000 4.0 -930 430 390 570 36,000 7000	m.		
DC grid voltage DC grid current Plate input power Typical Operation (Frequencies to 30MHz) DC plate voltage DC plate current DC grid voltage* DC grid current* Peak RF grid voltage* Driving Power* Plate input power Plate output power	4.0 -670 275 340 260 28,000 9000 19,000	250 -1000 0.6 40,000 9000 4.0 -930 430 390 570 36,000 7000 29,000	m.		
DC grid voltage DC grid current Plate input power Typical Operation (Frequencies to 30MHz) DC plate voltage DC plate current DC grid voltage* DC grid current* Peak RF grid voltage* Driving Power* Plate input power	4.0 -670 275 340 260 28,000 9000	250 -1000 0.6 40,000 9000 4.0 -930 430 390 570 36,000 7000	m.		
DC grid voltage DC grid current Plate input power Typical Operation (Frequencies to 30MHz) DC plate voltage DC plate current DC grid voltage* DC grid current* Peak RF grid voltage* Driving Power* Plate input power Plate dissipation Plate output power Approximate load impedance	4.0 -670 275 340 260 28,000 9000 19,000 720	250 -1000 0.6 40,000 9000 4.0 -930 430 390 570 36,000 7000 29,000	m.		
DC grid voltage DC grid current Plate input power Typical Operation (Frequencies to 30MHz) DC plate voltage DC plate current DC grid voltage* DC grid current* Peak RF grid voltage* Driving Power* Plate input power Plate dissipation Plate output power Approximate load impedance Audio or Radio Frequency Amplifier Service,	4.0 -670 275 340 260 28,000 9000 19,000 720	250 -1000 0.6 40,000 9000 4.0 -930 430 390 570 36,000 7000 29,000	m.		
DC grid voltage DC grid current Plate input power Typical Operation (Frequencies to 30MHz) DC plate voltage DC plate current DC grid voltage* DC grid current* Peak RF grid voltage* Driving Power* Plate input power Plate output power	4.0 -670 275 340 260 28,000 9000 19,000 720	250 -1000 0.6 40,000 9000 4.0 -930 430 390 570 36,000 7000 29,000	m.		
DC grid voltage DC grid current Plate input power Typical Operation (Frequencies to 30MHz) DC plate voltage DC plate current DC grid voltage* DC grid current* Peak RF grid voltage* Driving Power* Plate input power Plate dissipation Plate output power Approximate load impedance Maximum Ratings (per tube)	4.0 -670 275 340 260 28,000 9000 19,000 720	250 -1000 0.6 40,000 9000 4.0 -930 430 390 570 36,000 7000 29,000 1100 C	m. k k k k k k k k k k k k k k k k k k		
DC grid voltage DC grid current Plate input power Typical Operation (Frequencies to 30MHz) DC plate voltage DC plate current DC grid voltage* DC grid current* Peak RF grid voltage* Driving Power* Plate input power Plate dissipation Plate output power Approximate load impedance Maximum Ratings (per tube) DC plate voltage	4.0 -670 275 340 260 28,000 9000 19,000 720	250 -1000 0.6 40,000 9000 4.0 -930 430 390 570 36,000 7000 29,000 1100 C	m. l l l l l l l l l l l l l l l l l l l		

*Approximate values

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Electrical Application

Filament Operation The rated filament voltage for the 3CX10,000H3 is 7.50 volts. Filament voltage, as measured at the filament seals, should be maintained within 5% of this value to obtain maximum tube life.

High Frequency Operation Useful operation of the 3CX10,000H3 may be obtained to 140 MHz. Class C service at this frequency requires a reduction of maximum plate voltage to 7000 volts.

Mechanical Application

Mounting The 3CX10,000H3 must be mounted with its axis vertical. The base of the tube may be up or down.

Filament Connections The Svetlana 3CX10,000H3 filament connections are made via the attached flexible leads.

Grid Connection The mounting flange is also the electrical connection to the grid.

Cooling Sufficient forced-air circulation must be provided to keep the temperature of the anode core and the temperatures of the ceramic/metal seals below 250°C. Airflow requirements to maintain these temperatures below 225°C with an inletair temperature of 40°C are tabulated. Additional stem cooling is required. 10 cfm of airflow must be directed over the lead-to-tube connections for the filament leads. At frequencies above 30 MHz or at higher inlet-air temperatures or higher altitudes, more airflow will be required. The joints between the filament leads and the tube surfaces must be adequately cooled.

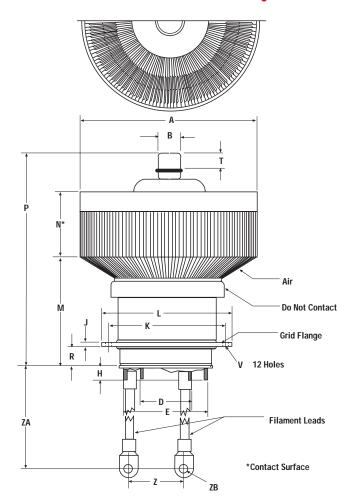
Base-to-Anode Air Flow								
	Sea Level		5000 Feet					
Anode* Dissipation Watts	Air Flow CFM	Pressure Drop Inches of Water	Air Flow CFM	Pressure Drop Inches of Water				
4000 6000	85 145	0.18 0.38	105 175	0.21 0.46				
8000 10,000 12,000	215 295 390	0.68 1.08 1.62	260 360 470	0.82 1.32 1.95				

^{*} Adequate cooling allowance is included for approximately 1000 watts of additional dissipation of filament and grid power



Svetlana 3CX10,000H3

Svetlana 3CX10,000H3 Outline Drawing





Dimensional Data								
Dim.	Millimeters			Inches				
	Ref.	Min.	Max.	Ref.	Min.	Max.		
Α	_	175.97	179.07		6.928	7.050		
В	_	21.72	27.50		0.855	0.895		
D	47.63	_		1.875	_			
Е	82.55	_		3.250	_	_		
Н	_	13.46	17.78	_	0.530	0.700		
J	3.18	_		0.125	_	_		
K	_	112.4	112.9	_	4.425	4.445		
L	_	127.62	129.29	_	5.030	5.090		
М		100.33	109.22		3.950	4.300		
N	_	61.27	70.82	_	2.412	2.788		
Р	_	209.55	222.25	_	8.250	8.750		
R		17.78	21.84		0.800	0.860		
Т	_	9.53	_	_	0.375			
V	6.35	_	_	0.250	_	_		
Z	50.8	_	_	2.000	_	_		
ZA	_	215.9	228.6	_	8.500	9.00		
ZB	9.91			0.390				

